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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/665,475	09/22/2003	Tetsuya Taki	T36-160821M/KOH	5511
21254	7590 01/05/2005		EXAMINER	
MCGINN & GIBB, PLLC			NGUYEN, TUAN H	
8321 OLD CO	URTHOUSE ROAD			
SUITE 200			ART UNIT	PAPER NUMBER
VIENNA, VA 22182-3817			2813	

DATE MAILED: 01/05/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

HA.

	Application No.	Applicant(s)				
	10/665,475	TAKI, TETSUYA				
Office Action Summary	Examiner	Art Unit				
	Tuan H. Nguyen	2813				
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address				
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	66(a). In no event, however, may a reply be time within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	ely filed swill be considered timely. the mailing date of this communication. O (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on <u>08 De</u>	Responsive to communication(s) filed on <u>08 December 2003</u> .					
,	This action is <b>FINAL</b> . 2b)⊠ This action is non-final.					
·—						
closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Disposition of Claims						
4) ⊠ Claim(s) 1-4 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration.  5) □ Claim(s) is/are allowed.  6) ⊠ Claim(s) 1-4 is/are rejected.  7) □ Claim(s) is/are objected to.  8) □ Claim(s) are subject to restriction and/or election requirement.						
Application Papers						
9)☐ The specification is objected to by the Examine 10)☑ The drawing(s) filed on <u>08 December 2003</u> is/a Applicant may not request that any objection to the of Replacement drawing sheet(s) including the correction of the original of the content of the original of the original or	re: a)⊠ accepted or b)⊡ object drawing(s) be held in abeyance. See ion is required if the drawing(s) is obj	ected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119						
<ul> <li>12)  Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a)  All b)  Some * c)  None of:</li> <li>1.  Certified copies of the priority documents have been received.</li> <li>2.  Certified copies of the priority documents have been received in Application No</li> <li>3.  Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>						
Attachment(s)						
1) Notice of References Cited (PTO-892)  4) Interview Summary (PTO-413)						
Notice of Draftsperson's Patent Drawing Review (PTO-948)   Paper No(s)/Mail Date						
S. Patent and Trademark Office						

#### **DETAILED ACTION**

## Claim Rejections - 35 USC § 112

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

Claim 4 is rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

In claim 4, it is unclear as to which amount of p-type impurities added to the second Group III nitride compound semiconductor layer is referred to. The amount adds in the step (iii) of forming a second group, or the amount diffused into the second group from the first group in the step of reducing resistance.

#### Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1-2 are rejected under 35 U.S.C. 102(e) as being anticipated by Stockman.

See Stockman, figs. 1-6 and related text on col. 4-5 which discloses the claimed method for producing p-type Group III nitride compound semiconductor including the steps of forming a first group III nitride compound layer 34 doped with p-type impurities; forming a second Group III nitride compound semiconductor layer 36 doped with substantially at least one of n-type impurities (figs. 4-6, and text on col. 4-5); reducing resistance after the step of forming the second Group III nitride compound semiconductor layer 36 by annealing (col. 4, last paragraph).

With respect to claim 2, fig. 2 shows the step of completing the device formation by removing layer 26 in fig. 2 for forming contact to the p-type layer in the subsequent step, after preparing the p-type layer with low resistance.

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 3-4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Stockman.

Application/Control Number: 10/665,475

Art Unit: 2813

Stockman, figs 1-6 and text on col. 4-5 as explained above, discloses substantially the claimed method for forming p-type Group III nitride compound semiconductor except the thickness of the second Group III nitride layer, and the diffusion of p-type impurities.

However, as shown in figs. 4, 6, the thicknesses tp of the first Group III nitride layer 34 is about the same as the second Group III nitride layer 36, and col. 4, lines 45-46 discloses the thickness tp is approximately 500 to 5 microns which is within the claimed range.

It would have been obvious to one having ordinary skill in the art at the time the invention was made to have selected a suitable thickness within the claimed range in the process for forming a semiconductor as suggested by Stockman for an optimum result.

With respect to claim 4, it would have been obvious to those skill in the art at the time the invention was made to have recognized that by heating the structure in the step of reducing resistance, the p-type impurities would inherently diffused from first Group III nitride layer into the second Group III nitride layer in a smaller amount with the promotion of the n-type impurities in the second Group III layer.

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Sakai, Kaneko, and Ye et al. disclose method for reducing resistance in p-type compound semiconductor layer.

Art Unit: 2813

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Tuan H. Nguyen whose telephone number is 571-272-1694. The examiner can normally be reached on 9AM-5:30PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead Jr. can be reached on 571-272-1702. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Tuan H. Nguyen
Primary Examiner
Art Unit 2813